**Product data sheet** 

# 1. General description

High-speed switching diode, encapsulated in an SOD123 small Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- High switching speed: t<sub>rr</sub> ≤ 4 ns
- Low leakage current
- Reverse voltage V<sub>R</sub> ≤ 100 V
- Low capacitance: C<sub>d</sub> ≤ 1.5 pF
- Small SMD plastic package
- AEC-Q101 qualified

# 3. Applications

- · High-speed switching at high voltage
- General-purpose switching

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C	-	-	100	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 80 V; pulsed; T <sub>j</sub> = 25 °C	-	-	0.5	μΑ
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; Switched from $I_F$ = 10 mA to $I_R$ = 10 mA; $T_j$ = 25 °C	-	-	4	ns



**High-speed switching diode** 

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	Cathode	1 2	1 1 2
2	А	Anode	SOD123	sym001

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package					
	Name	Description	Version			
BAS16GW	SOD123	Plastic surface-mounted package; 2 leads	SOD123			

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
BAS16GW	GA

**High-speed switching diode** 

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	T <sub>j</sub> = 25 °C		-	100	V
$V_R$	reverse voltage			-	100	V
I <sub>F</sub>	forward current			-	215	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 0.5 \text{ ms}; \delta \le 0.25$		-	500	mA
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 1 µs; $T_{j(init)}$ = 25 °C; square wave		-	4	Α
	forward current	$t_p$ = 1 ms; $T_{j(init)}$ = 25 °C; square wave		-	1	Α
		$t_p$ = 1 s; $T_{j(init)}$ = 25 °C; square wave		-	0.5	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	357	mW
			[2]	-	600	mW
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	In free air	[1]	-	-	350	K/W
			[2]	-	-	210	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[3]	-	-	58	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1cm<sup>2</sup>.

Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm<sup>2</sup>.

<sup>[3]</sup> Soldering point of cathode tab.

### High-speed switching diode

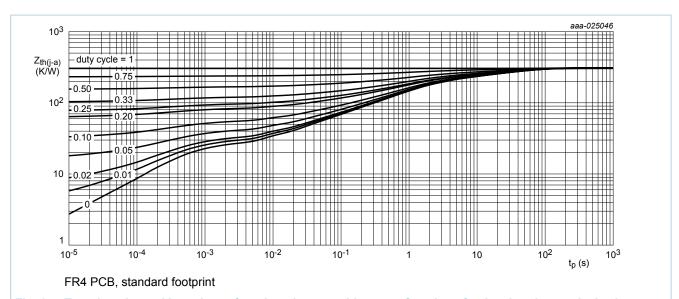


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

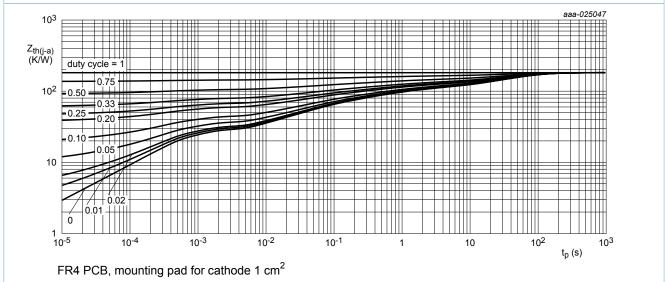


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

**High-speed switching diode** 

### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub> forward vol	forward voltage	$I_F$ = 1 mA; $t_p \le 300$ μs; $δ$ = 0.02 ; $T_j$ = 25 °C	-	-	715	mV
		$I_F$ = 10 mA; $t_p \le 300$ μs; $δ$ = 0.02 ; $T_j$ = 25 °C	-	-	855	mV
		$I_F = 50 \text{ mA}; t_p \le 300  \mu\text{s}; \delta = 0.02 ; $ $T_j = 25 ^{\circ}\text{C}$	-	-	1	V
		$I_F$ = 150 mA; $t_p \le 300$ μs; $δ$ = 0.02 ; $T_j$ = 25 °C	-	-	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25 V; pulsed; T <sub>j</sub> = 25 °C	-	-	30	nA
		V <sub>R</sub> = 80 V; pulsed; T <sub>j</sub> = 25 °C	-	-	0.5	μΑ
		V <sub>R</sub> = 25 V; pulsed; T <sub>j</sub> = 150 °C	-	-	30	μΑ
		V <sub>R</sub> = 80 V; pulsed; T <sub>j</sub> = 150 °C	-	-	50	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	1.5	pF
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; Switched from $I_F$ = 10 mA to $I_R$ = 10 mA; $T_j$ = 25 °C	-	-	4	ns
$V_{FR}$	forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}$	-	-	1.75	V

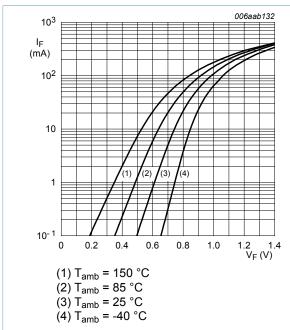
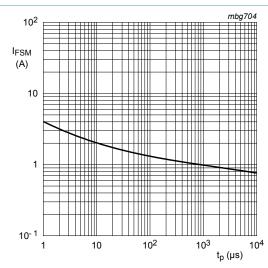


Fig. 3. Forward current as a function of forward voltage; typical values



Based on square wave currents.  $T_{j(init)} = 25 \text{ °C}$ 

Fig. 4. Non-repetitive peak forward current as a function of pulse duration; maximum values

#### **High-speed switching diode**

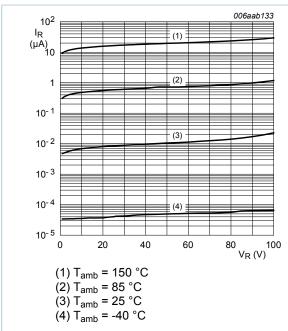
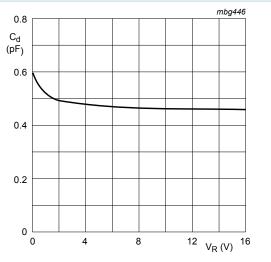


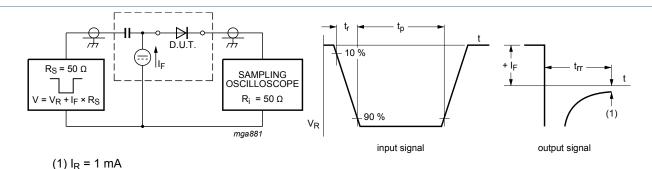
Fig. 5. Reverse current as a function of reverse voltage; typical values



 $f = 1 MHz; T_{amb} = 25 °C$ 

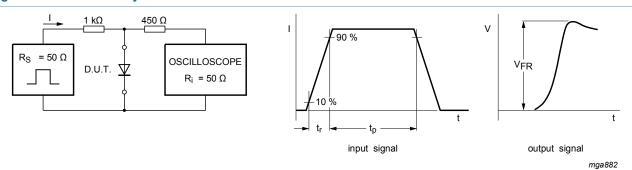
Fig. 6. Diode capacitance as a function of reverse voltage; typical values

## 11. Test information



Input signal: reverse pulse rise time  $t_r$  = 0.6 ns; reverse voltage pulse duration  $t_p$  = 100 ns; duty cycle  $\delta$  = 0.05 Oscilloscope: rise time  $t_r$  = 0.35 ns

#### Fig. 7. Reverse recovery time test circuit and waveforms

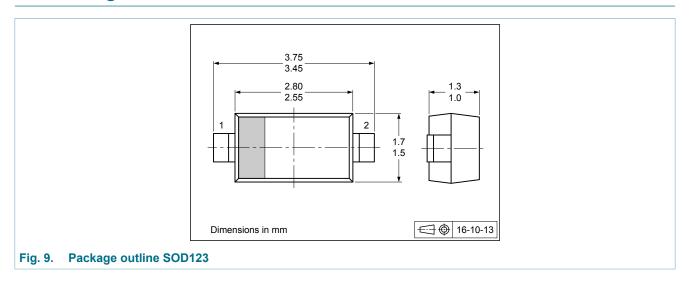


Input signal: forward pulse rise time  $t_r$  = 20 ns; forward current pulse duration  $t_p \ge 100$  ns; duty cycle  $\delta \le 0.005$ 

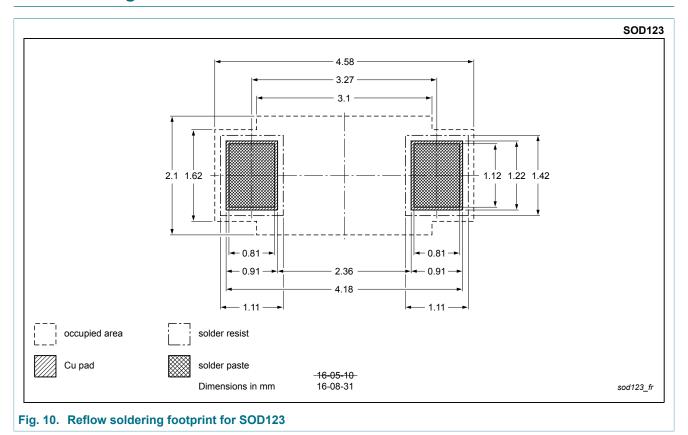
Fig. 8. Forward recovery voltage test circuit and waveforms

**High-speed switching diode** 

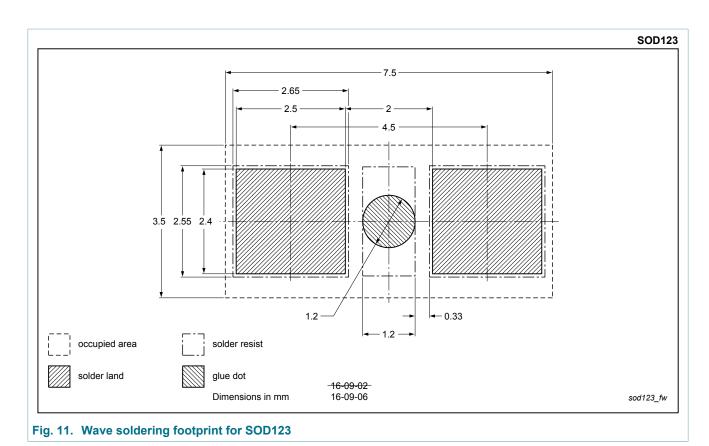
# 12. Package outline



# 13. Soldering



## **High-speed switching diode**



**High-speed switching diode** 

# 14. Revision history

### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS16GW v.1	20161123	Product data sheet	-	-

#### **High-speed switching diode**

# 15. Legal information

#### **Data sheet status**

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BAS16GW

High-speed switching diode

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## High-speed switching diode

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